

- Designed for SDARS Receiver IF Application
- Low Insertion Loss
- 3.8 X 3.8 mm Surface-Mount Case
- · Differential Input and Output
- Complies with Directive 2002/95/EC (RoHS)

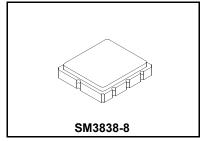


Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Max. DC voltage between any 2 terminals	30	VDC
Storage Temperature Range	-40 to +105	°C
Suitable for lead-free soldering - Max Soldering Temperature	260°C for 30 s	

SF2025D

259.861 MHz SAW Filter



Characteristic	Sym	Notes	Min	Тур	Max	Units
Nominal Center Frequency		1	259.861		MHz	
Passband Minimum Insertion Loss		'		16	18	dB
1.5 dB Passband	BW _{1.5}			13.6		MHz
3 dB Passband	BW ₃			14.3		IVITZ
Amplitude Ripple from fc-6.354 MHz to fc-4.2885 MHz (-20 to 85°C)				0.5	1	
Amplitude Ripple from fc-6.354 MHz to fc-4.2885 MHz (-40 to -20°C)				0.5	1.5	
Amplitude Ripple from fc-4.4965 MHz to fc-2.431 MHz				0.5	1	1
Amplitude Ripple from fc-2.639 MHz to fc+0.079 MHz				0.5	1	dB _{P-P}
Amplitude Ripple from fc-0.079 MHz to fc+2.639 MHz		1, 2		0.5	1	_ ubp_p
Amplitude Ripple from fc+2.431 MHz to fc+4.4965 MHz				0.5	1	_ _ _
Amplitude Ripple from fc+4.2885 MHz to fc+6.354 MHz (-40 to 60°C)				0.5	1	
Amplitude Ripple from fc+4.2885 MHz to fc+6.354 MHz (60 to 85°C)				0.5	1.15	
Group Delay Variation over fc-6.354 MHz to fc-2.431 MHz				90	120	
and from fc+2.431 MHz to fc+6.354 MHz				90	120	ns _{P-P}
Group Delay Variation over fc±2.639 MHz				60	120	
Rejection fc-28 to fc-12 MHz and fc+12 to fc+33 MHz			36	43		
fc-12 to fc-10.5 MHz		1, 2, 3	30	40		dB
fc+9 to fc+12 MHz			26	36		
Operating Temperature Range		1	-40		+85	°C
Frequency Temperature Coefficeint				-18		ppm/°C
Differential Input and Output Impedance		•	L&CM	atch to 150 ohr	ns	•
Case Style		7	SM38	38-8 3.8 x 3.8	mm Nominal F	ootprint
Lid Symbolization (YY=year, WW=week, S=shift)		1 '		634 \	YYWW_	

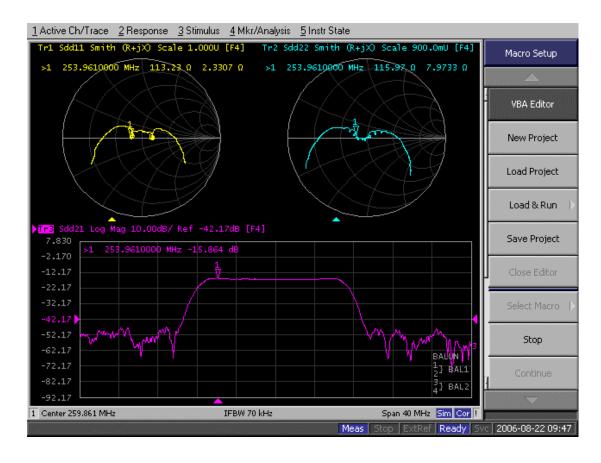
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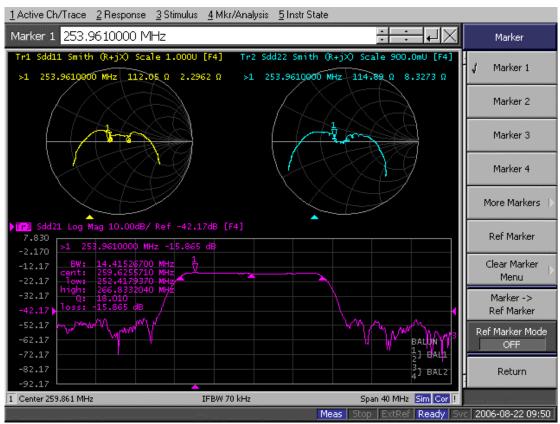
- 1. Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50 Ω and measured with 50 Ω network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- The design, manufacturing process, and specifications of this filter are subject to change.
- 5. Tape and Reel Standard Per ANSI / EIA 481.
- Either Port 1 or Port 2 may be used for either input or output in the design.
 However, impedances and impedance matching may vary between Port 1 and
 Port 2, so that the filter must always be installed in one direction per the circuit
 design.
- US and international patents may apply.
- Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.

Electrostatic Sensitive Device. Observe precautions for handling.



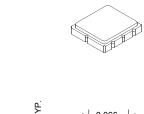
400-1724-001	PCB, 4 PORT, 3X3MM	PCB
SF2025D	FILTER, 259.861 MHZ	FILTER
501-0857-056	CAP, 5.6 PF, 0402CS	C1,C2
501-0857-050	CAP, 5.0 PF, 0402CS	C3,C4
501-0857-010	CAP, 1.0 PF, 0402CS	C5
500-1282-390	IND, 39 NH, 0402CS	L1 COILCRAFT
500-1282-510	IND, 51 NH, 0402CS	L2 COILCRAFT

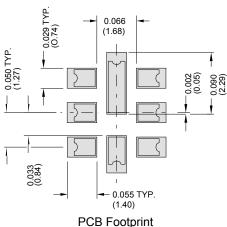




SM3838-8 Case

8-Terminal Ceramic Surface-Mount Case 3.8 X 3.8 mm Nominal Footprint

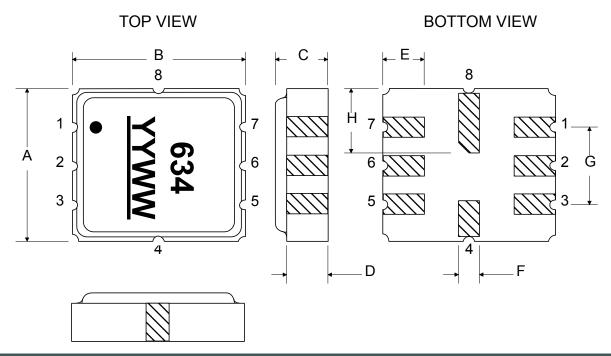




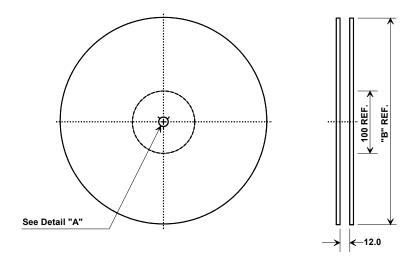
Case Dimensions						
Dimension	Dimension mm		Inches			
Dilliension	Min	Nom	Max	Min	Nom	Max
Α	3.6	3.8	4.0	0.142	0.150	0.157
В	3.6	3.8	4.0	0.142	0.150	0.157
С	0.95	1.10	1.25	0.037	0.043	0.049
D	0.60	0.85	1.00	0.023	0.033	0.039
E	0.90	1.00	1.10	0.035	0.040	0.043
F	0.50	0.60	0.70	0.020	0.024	0.028
G	2.39	2.54	2.69	0.090	0.100	0.110
Н	1.35	1.5	1.65	0.053	0.059	0.065

Electrical Connections			
	Connection	Terminals	
Port 1	Differential Input	1, 2	
Port 2	Differential Output	5, 6	
	Ground	All Others	
Single Ended Operation Return is Grou		Return is Ground	
Differential Operation		Return is Hot	
Dot Indicates Pin	1		

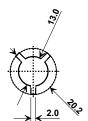
Materials				
Solder Pad Ter- mination	Au plating 30 - 60 ulnches (76.2-152 uM) over 80-200 ulnches (203-508 uM) Ni.			
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 ulnches Thick			
Body	Al ₂ O ₃ Ceramic			
Pb Free				



Tape and Reel Specifications



"B " Nominal Size		Quantity Per Reel
Inches	millimeters	
7	178	1000
13	330	3000



COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions		
Ao	4.25 mm	
Во	4.25 mm	
Ко	1.60 mm	
Pitch	8.0 mm	
W	12.0 mm	

